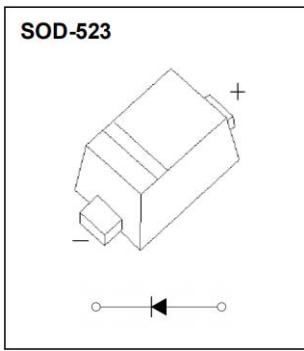


SOD-523 贴片塑封二极管

SOD-523 Plastic-Encapsulate Diodes

**MARKING: S4****特征 Features**

- 低正向电压差 Low Forward Voltage Drop
- 用于瞬态保护的保护环结构 Guard Ring Construction for Transient Protection
- 反向恢复时间低 Low Reverse Recovery Time
- 反向电容低 Low Reverse Capacitance

机械数据 Mechanical Data

- 封装: SOD-523 封装 SOD-523 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

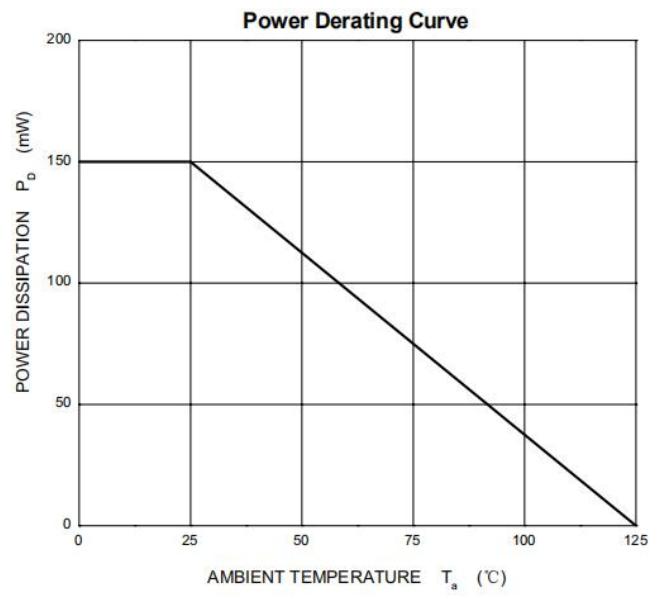
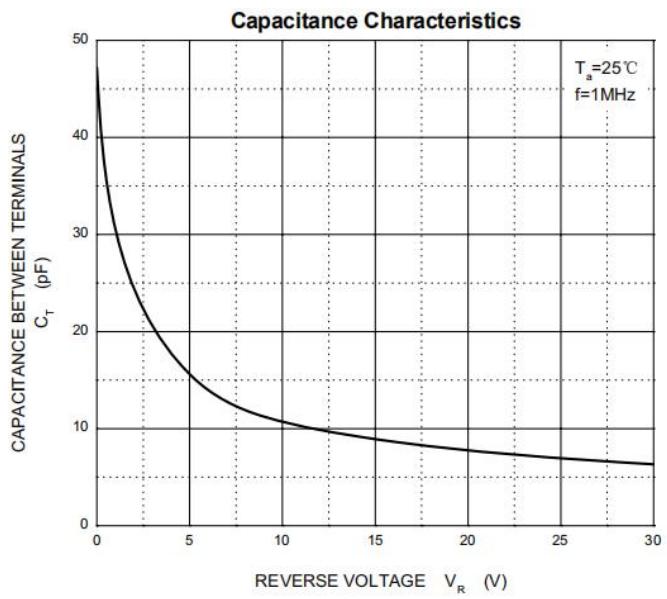
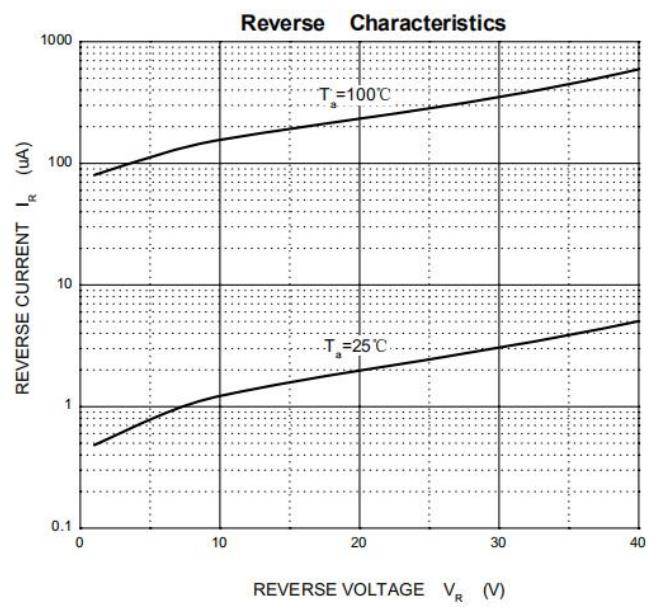
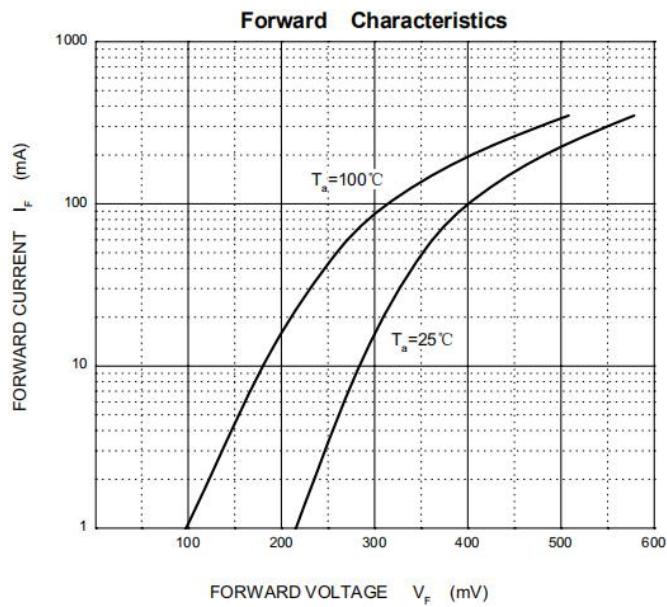
极限值和温度特性($T_A = 25^\circ\text{C}$ 除非另有规定)**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
直流阻断电压 DC Blocking Voltage	V_R		
峰值重复反向电压 Peak Repetitive Reverse Voltage	V_{RRM}	40	V
反向峰值工作电压 Working Peak Reverse Voltage	V_{RWM}		
均方根反向电压 RMS Reverse Voltage	$V_{R(RMS)}$	28	V
正向连续电流 Forward Continuous Current	I_{FM}	350	mA
尖峰正向不重复浪涌电流 Non-repetitive Peak Forward Surge Current@ $t= 8.3\text{ms}$	I_{FSM}	2	A
功率消耗 Power Dissipation	P_d	150	mW
结温 Junction temperature	T_j	125	°C
存储温度 Storage temperature range	T_{STG}	-55~+150	°C
热阻 Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	667	°C/W

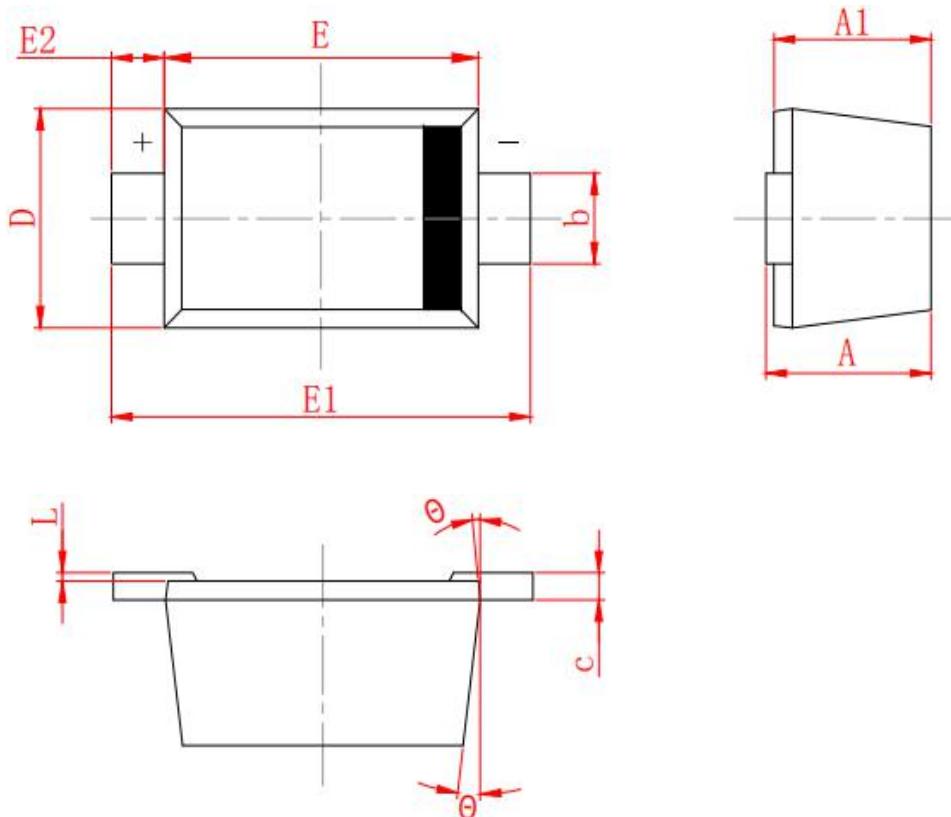
电特性 Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

符号 Symbols	参数 Parameter	测试条件 Test Condition	界限 Limits			单位 Unit
			Min	Typ	Max	
$V(BR)$	反向击穿电压 Reverse Breakdown Voltage	$I_R=100\mu\text{A}$	40			V
I_R	反向漏电流 Reverse Current	$VR=30\text{V}$			5	uA
		$VR=20\text{V}$			2	
		$VR=10\text{V}$			1	
V_F	正向电压 Forward Voltage	$I_F=1\text{mA}$		0.27		V
		$I_F=5\text{mA}$		0.32		
		$I_F=20\text{mA}$			0.37	
		$I_F=200\text{mA}$			0.6	
T_{rr}	反向恢复时间 Reverse Recovery Time	$I_F = I_R = 200\text{mA},$		10		nS
		$I_{rr}=0.1 \times I_R, R_L=100\Omega$				
C_{tot}	端子间电容 Total Capacitance	$VR=0\text{V}, f=1\text{MHz}$		50		pF

典型特性 Typical Characteristics

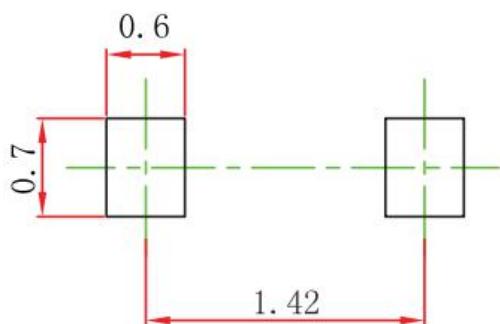


SOD-523封装外形尺寸图 SOD-523 Package Outline Dimensions



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.530	0.730
A1	0.500	0.700
b	0.280	0.380
c	0.080	0.150
D	0.750	0.850
E	1.100	1.300
E1	1.500	1.700
E2	0.200	REF
L	0.010	0.070
θ	7°	REF

SOD-523焊盘设计参考 SOD-523 Suggested Pad Layout



Note:

1. Controlling dimension:in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.